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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| | |
|--------------------------------|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | 158500 |
| Number of Logic Elements/Cells | 420000 |
| Total RAM Bits | 37888000 |
| Number of I/O | 600 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 1152-BBGA, FCBGA |
| Supplier Device Package | 1152-FBGA (35x35) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxma4k3f35c4n |

Table 7. Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, GS, and GT Devices (Part 2 of 2)

| Symbol | Description | Devices | Minimum ⁽⁴⁾ | Typical | Maximum ⁽⁴⁾ | Unit |
|------------------------|--|------------|------------------------|---------|------------------------|------|
| V_{CCR_GXBR} (2) | Receiver analog power supply (right side) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | | | 0.87 | 0.90 | 0.93 | |
| | | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |
| V_{CCR_GTBR} | Receiver analog power supply for GT channels (right side) | GT | 1.02 | 1.05 | 1.08 | V |
| V_{CCT_GXBL} (2) | Transmitter analog power supply (left side) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | | | 0.87 | 0.90 | 0.93 | |
| | | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |
| V_{CCT_GXBR} (2) | Transmitter analog power supply (right side) | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| | | | 0.87 | 0.90 | 0.93 | |
| | | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |
| V_{CCT_GTBR} | Transmitter analog power supply for GT channels (right side) | GT | 1.02 | 1.05 | 1.08 | V |
| V_{CCL_GTBR} | Transmitter clock network power supply | GT | 1.02 | 1.05 | 1.08 | V |
| V_{CCH_GXBL} | Transmitter output buffer power supply (left side) | GX, GS, GT | 1.425 | 1.5 | 1.575 | V |
| V_{CCH_GXBR} | Transmitter output buffer power supply (right side) | GX, GS, GT | 1.425 | 1.5 | 1.575 | V |

Notes to Table 7:

- (1) This supply must be connected to 3.0 V if the CMU PLL, receiver CDR, or both, are configured at a base data rate > 6.5 Gbps. Up to 6.5 Gbps, you can connect this supply to either 3.0 V or 2.5 V.
- (2) Refer to Table 8 to select the correct power supply level for your design.
- (3) When using ATX PLLs, the supply must be 3.0 V.
- (4) This value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Table 8 shows the transceiver power supply voltage requirements for various conditions.

Table 8. Transceiver Power Supply Voltage Requirements

| Conditions | Core Speed Grade | VCCR_GXB & VCCT_GXB ⁽²⁾ | VCCA_GXB | VCCH_GXB | Unit |
|---|-----------------------------------|------------------------------------|----------|----------|------|
| If BOTH of the following conditions are true: <ul style="list-style-type: none"> ■ Data rate > 10.3 Gbps. ■ DFE is used. | All | 1.05 | 3.0 | 1.5 | V |
| If ANY of the following conditions are true ⁽¹⁾ : <ul style="list-style-type: none"> ■ ATX PLL is used. ■ Data rate > 6.5Gbps. ■ DFE (data rate ≤ 10.3 Gbps), AEQ, or EyeQ feature is used. | All | 1.0 | | | |
| If ALL of the following conditions are true: <ul style="list-style-type: none"> ■ ATX PLL is not used. ■ Data rate ≤ 6.5Gbps. ■ DFE, AEQ, and EyeQ are not used. | C1, C2, I2, and I3YY | 0.90 | 2.5 | | |
| | C2L, C3, C4, I2L, I3, I3L, and I4 | 0.85 | 2.5 | | |

Notes to Table 8:

- (1) Choose this power supply voltage requirement option if you plan to upgrade your design later with any of the listed conditions.
- (2) If the VCCR_GXB and VCCT_GXB supplies are set to 1.0 V or 1.05 V, they cannot be shared with the VCC core supply. If the VCCR_GXB and VCCT_GXB are set to either 0.90 V or 0.85 V, they can be shared with the VCC core supply.

DC Characteristics

This section lists the supply current, I/O pin leakage current, input pin capacitance, on-chip termination tolerance, and hot socketing specifications.

Supply Current

Supply current is the current drawn from the respective power rails used for power budgeting. Use the Excel-based Early Power Estimator (EPE) to get supply current estimates for your design because these currents vary greatly with the resources you use.



For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 2 of 2) ⁽¹⁾

| Symbol | Description | V _{CCIO} (V) | Typical | Unit |
|--------|--|-----------------------|---------|-------------------|
| dR/dT | OCT variation with temperature without recalibration | 3.0 | 0.189 | %/ ^o C |
| | | 2.5 | 0.208 | |
| | | 1.8 | 0.266 | |
| | | 1.5 | 0.273 | |
| | | 1.2 | 0.317 | |

Note to Table 13:

(1) Valid for a V_{CCIO} range of $\pm 5\%$ and a temperature range of 0° to 85°C.

Pin Capacitance

Table 14 lists the Stratix V device family pin capacitance.

Table 14. Pin Capacitance for Stratix V Devices

| Symbol | Description | Value | Unit |
|--------------------|--|-------|------|
| C _{IOTB} | Input capacitance on the top and bottom I/O pins | 6 | pF |
| C _{IOLR} | Input capacitance on the left and right I/O pins | 6 | pF |
| C _{OUTFB} | Input capacitance on dual-purpose clock output and feedback pins | 6 | pF |

Hot Socketing

Table 15 lists the hot socketing specifications for Stratix V devices.

Table 15. Hot Socketing Specifications for Stratix V Devices

| Symbol | Description | Maximum |
|---------------------------|--|---------------------|
| I _{IOPIN} (DC) | DC current per I/O pin | 300 μ A |
| I _{IOPIN} (AC) | AC current per I/O pin | 8 mA ⁽¹⁾ |
| I _{XCVR-TX} (DC) | DC current per transceiver transmitter pin | 100 mA |
| I _{XCVR-RX} (DC) | DC current per transceiver receiver pin | 50 mA |

Note to Table 15:

(1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns, $|I_{IOPIN}| = C \, dv/dt$, in which C is the I/O pin capacitance and dv/dt is the slew rate.

Internal Weak Pull-Up Resistor

Table 16 lists the weak pull-up resistor values for Stratix V devices.

Table 16. Internal Weak Pull-Up Resistor for Stratix V Devices ^{(1), (2)}

| Symbol | Description | V _{CCIO} Conditions (V) ⁽³⁾ | Value ⁽⁴⁾ | Unit |
|-----------------|---|---|----------------------|------|
| R _{PU} | Value of the I/O pin pull-up resistor before and during configuration, as well as user mode if you enable the programmable pull-up resistor option. | 3.0 ±5% | 25 | kΩ |
| | | 2.5 ±5% | 25 | kΩ |
| | | 1.8 ±5% | 25 | kΩ |
| | | 1.5 ±5% | 25 | kΩ |
| | | 1.35 ±5% | 25 | kΩ |
| | | 1.25 ±5% | 25 | kΩ |
| | | 1.2 ±5% | 25 | kΩ |

Notes to Table 16:

- (1) All I/O pins have an option to enable the weak pull-up resistor except the configuration, test, and JTAG pins.
- (2) The internal weak pull-down feature is only available for the JTAG TCK pin. The typical value for this internal weak pull-down resistor is approximately 25 kΩ.
- (3) The pin pull-up resistance values may be lower if an external source drives the pin higher than V_{CCIO}.
- (4) These specifications are valid with a ±10% tolerance to cover changes over PVT.

I/O Standard Specifications

Table 17 through Table 22 list the input voltage (V_{IH} and V_{IL}), output voltage (V_{OH} and V_{OL}), and current drive characteristics (I_{OH} and I_{OL}) for various I/O standards supported by Stratix V devices. These tables also show the Stratix V device family I/O standard specifications. The V_{OL} and V_{OH} values are valid at the corresponding I_{OH} and I_{OL}, respectively.

For an explanation of the terms used in Table 17 through Table 22, refer to “Glossary” on page 65. For tolerance calculations across all SSTL and HSTL I/O standards, refer to Altera knowledge base solution rd07262012_486.

Table 17. Single-Ended I/O Standards for Stratix V Devices

| I/O Standard | V _{CCIO} (V) | | | V _{IL} (V) | | V _{IH} (V) | | V _{OL} (V) | V _{OH} (V) | I _{OL} (mA) | I _{OH} (mA) |
|--------------|-----------------------|-----|-------|---------------------|-----------------------------|-----------------------------|-------------------------|-----------------------------|-----------------------------|----------------------|----------------------|
| | Min | Typ | Max | Min | Max | Min | Max | Max | Min | | |
| LVTTTL | 2.85 | 3 | 3.15 | −0.3 | 0.8 | 1.7 | 3.6 | 0.4 | 2.4 | 2 | −2 |
| LVC MOS | 2.85 | 3 | 3.15 | −0.3 | 0.8 | 1.7 | 3.6 | 0.2 | V _{CCIO} − 0.2 | 0.1 | −0.1 |
| 2.5 V | 2.375 | 2.5 | 2.625 | −0.3 | 0.7 | 1.7 | 3.6 | 0.4 | 2 | 1 | −1 |
| 1.8 V | 1.71 | 1.8 | 1.89 | −0.3 | 0.35 * V _{CCIO} | 0.65 * V _{CCIO} | V _{CCIO} + 0.3 | 0.45 | V _{CCIO} − 0.45 | 2 | −2 |
| 1.5 V | 1.425 | 1.5 | 1.575 | −0.3 | 0.35 * V _{CCIO} | 0.65 * V _{CCIO} | V _{CCIO} + 0.3 | 0.25 * V _{CCIO} | 0.75 * V _{CCIO} | 2 | −2 |
| 1.2 V | 1.14 | 1.2 | 1.26 | −0.3 | 0.35 * V _{CCIO} | 0.65 * V _{CCIO} | V _{CCIO} + 0.3 | 0.25 * V _{CCIO} | 0.75 * V _{CCIO} | 2 | −2 |



-  You typically use the interactive Excel-based Early Power Estimator before designing the FPGA to get a magnitude estimate of the device power. The Quartus II PowerPlay Power Analyzer provides better quality estimates based on the specifics of the design after you complete place-and-route. The PowerPlay Power Analyzer can apply a combination of user-entered, simulation-derived, and estimated signal activities that, when combined with detailed circuit models, yields very accurate power estimates.
-  For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 5 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|---|--|------------------------------|---------------------|-------|------------------------------|---------------------|-------|------------------------------|---------------------|-------------------------------------|----------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Programmable DC gain | DC Gain Setting = 0 | — | 0 | — | — | 0 | — | — | 0 | — | dB |
| | DC Gain Setting = 1 | — | 2 | — | — | 2 | — | — | 2 | — | dB |
| | DC Gain Setting = 2 | — | 4 | — | — | 4 | — | — | 4 | — | dB |
| | DC Gain Setting = 3 | — | 6 | — | — | 6 | — | — | 6 | — | dB |
| | DC Gain Setting = 4 | — | 8 | — | — | 8 | — | — | 8 | — | dB |
| Transmitter | | | | | | | | | | | |
| Supported I/O Standards | — | 1.4-V and 1.5-V PCML | | | | | | | | | |
| Data rate (Standard PCS) | — | 600 | — | 12200 | 600 | — | 12200 | 600 | — | 8500/ 10312.5 ⁽²⁴⁾ | Mbps |
| Data rate (10G PCS) | — | 600 | — | 14100 | 600 | — | 12500 | 600 | — | 8500/ 10312.5 ⁽²⁴⁾ | Mbps |
| Differential on- chip termination resistors | 85- Ω setting | — | 85 \pm 20% | — | — | 85 \pm 20% | — | — | 85 \pm 20% | — | Ω |
| | 100- Ω setting | — | 100 \pm 20% | — | — | 100 \pm 20% | — | — | 100 \pm 20% | — | Ω |
| | 120- Ω setting | — | 120 \pm 20% | — | — | 120 \pm 20% | — | — | 120 \pm 20% | — | Ω |
| | 150- Ω setting | — | 150 \pm 20% | — | — | 150 \pm 20% | — | — | 150 \pm 20% | — | Ω |
| V _{OCM} (AC coupled) | 0.65-V setting | — | 650 | — | — | 650 | — | — | 650 | — | mV |
| V _{OCM} (DC coupled) | — | — | 650 | — | — | 650 | — | — | 650 | — | mV |
| Rise time ⁽⁷⁾ | 20% to 80% | 30 | — | 160 | 30 | — | 160 | 30 | — | 160 | ps |
| Fall time ⁽⁷⁾ | 80% to 20% | 30 | — | 160 | 30 | — | 160 | 30 | — | 160 | ps |
| Intra-differential pair skew | Tx V _{CM} = 0.5 V and slew rate of 15 ps | — | — | 15 | — | — | 15 | — | — | 15 | ps |
| Intra-transceiver block transmitter channel-to- channel skew | x6 PMA bonded mode | — | — | 120 | — | — | 120 | — | — | 120 | ps |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 6 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|---|--|------------------------------|-----|-------------------------------|------------------------------|-----|-------------------------------|------------------------------|-----|-------------------------------------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Inter-transceiver block transmitter channel-to- channel skew | xN PMA bonded mode | — | — | 500 | — | — | 500 | — | — | 500 | ps |
| CMU PLL | | | | | | | | | | | |
| Supported Data Range | — | 600 | — | 12500 | 600 | — | 12500 | 600 | — | 8500/ 10312.5 ⁽²⁴⁾ | Mbps |
| t _{pll_powerdown} ⁽¹⁵⁾ | — | 1 | — | — | 1 | — | — | 1 | — | — | μs |
| t _{pll_lock} ⁽¹⁶⁾ | — | — | — | 10 | — | — | 10 | — | — | 10 | μs |
| ATX PLL | | | | | | | | | | | |
| Supported Data Rate Range | VCO post-divider L=2 | 8000 | — | 14100 | 8000 | — | 12500 | 8000 | — | 8500/ 10312.5 ⁽²⁴⁾ | Mbps |
| | L=4 | 4000 | — | 7050 | 4000 | — | 6600 | 4000 | — | 6600 | Mbps |
| | L=8 | 2000 | — | 3525 | 2000 | — | 3300 | 2000 | — | 3300 | Mbps |
| | L=8, Local/Central Clock Divider =2 | 1000 | — | 1762.5 | 1000 | — | 1762.5 | 1000 | — | 1762.5 | Mbps |
| t _{pll_powerdown} ⁽¹⁵⁾ | — | 1 | — | — | 1 | — | — | 1 | — | — | μs |
| t _{pll_lock} ⁽¹⁶⁾ | — | — | — | 10 | — | — | 10 | — | — | 10 | μs |
| fPLL | | | | | | | | | | | |
| Supported Data Range | — | 600 | — | 3250/ 3125 ⁽²⁵⁾ | 600 | — | 3250/ 3125 ⁽²⁵⁾ | 600 | — | 3250/ 3125 ⁽²⁵⁾ | Mbps |
| t _{pll_powerdown} ⁽¹⁵⁾ | — | 1 | — | — | 1 | — | — | 1 | — | — | μs |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 7 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|------------------------|------------|------------------------------|-----|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| $t_{pll_lock}^{(16)}$ | — | — | — | 10 | — | — | 10 | — | — | 10 | μs |

Notes to Table 23:

- (1) Speed grades shown in Table 23 refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the *Stratix V Device Overview*.
- (2) The reference clock common mode voltage is equal to the V_{CCR_GXB} power supply level.
- (3) This supply must be connected to 1.0 V if the transceiver is configured at a data rate > 6.5 Gbps, and to 1.05 V if configured at a data rate > 10.3 Gbps when DFE is used. For data rates up to 6.5 Gbps, you can connect this supply to 0.85 V.
- (4) This supply follows V_{CCR_GXB} .
- (5) The device cannot tolerate prolonged operation at this absolute maximum.
- (6) The differential eye opening specification at the receiver input pins assumes that **Receiver Equalization** is disabled. If you enable **Receiver Equalization**, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.
- (7) The Quartus II software automatically selects the appropriate slew rate depending on the configured data rate or functional mode.
- (8) The input reference clock frequency options depend on the data rate and the device speed grade.
- (9) The line data rate may be limited by PCS-FPGA interface speed grade.
- (10) Refer to Figure 1 for the GX channel AC gain curves. The total effective AC gain is the AC gain minus the DC gain.
- (11) t_{LTR} is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.
- (12) t_{LTD} is time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high.
- (13) t_{LTD_manual} is the time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high when the CDR is functioning in the manual mode.
- (14) $t_{LTR_LTD_manual}$ is the time the receiver CDR must be kept in lock to reference (LTR) mode after the rx_is_lockedtoref signal goes high when the CDR is functioning in the manual mode.
- (15) $t_{pll_powerdown}$ is the PLL powerdown minimum pulse width.
- (16) t_{pll_lock} is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.
- (17) To calculate the REFCLK rms phase jitter requirement for PCIe at reference clock frequencies other than 100 MHz, use the following formula: REFCLK rms phase jitter at f(MHz) = REFCLK rms phase jitter at 100 MHz × 100/f.
- (18) The maximum peak to peak differential input voltage V_{ID} after device configuration is equal to $4 \times (\text{absolute } V_{MAX} \text{ for receiver pin} - V_{ICM})$.
- (19) For ES devices, R_{REF} is $2000 \Omega \pm 1\%$.
- (20) To calculate the REFCLK phase noise requirement at frequencies other than 622 MHz, use the following formula: REFCLK phase noise at f(MHz) = REFCLK phase noise at 622 MHz + $20 \times \log(f/622)$.
- (21) SFP/+ optical modules require the host interface to have RD+/- differentially terminated with 100Ω . The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (22) Refer to Figure 2.
- (23) For oversampling designs to support data rates less than the minimum specification, the CDR needs to be in LTR mode only.
- (24) I3YY devices can achieve data rates up to 10.3125 Gbps.
- (25) When you use fPLL as a TXPLL of the transceiver.
- (26) REFCLK performance requires to meet transmitter REFCLK phase noise specification.
- (27) Minimum eye opening of 85 mV is only for the unstressed input eye condition.

Table 25 shows the approximate maximum data rate using the standard PCS.

Table 25. Stratix V Standard PCS Approximate Maximum Date Rate ⁽¹⁾, ⁽³⁾

| Mode ⁽²⁾ | Transceiver Speed Grade | PMA Width | 20 | 20 | 16 | 16 | 10 | 10 | 8 | 8 |
|---------------------|-------------------------|---------------------------------------|---------|---------|---------|---------|-----|-----|------|------|
| | | PCS/Core Width | 40 | 20 | 32 | 16 | 20 | 10 | 16 | 8 |
| FIFO | 1 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.5 | 5.8 | 5.2 | 4.72 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.5 | 5.8 | 5.2 | 4.72 |
| | | C3, I3, I3L core speed grade | 9.8 | 9.0 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | 3 | C1, C2, C2L, I2, I2L core speed grade | 8.5 | 8.5 | 8.5 | 8.5 | 6.5 | 5.8 | 5.2 | 4.72 |
| | | I3YY core speed grade | 10.3125 | 10.3125 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | | C3, I3, I3L core speed grade | 8.5 | 8.5 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | | C4, I4 core speed grade | 8.5 | 8.2 | 7.04 | 6.56 | 4.8 | 4.2 | 3.84 | 3.44 |
| Register | 1 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.1 | 5.7 | 4.88 | 4.56 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.1 | 5.7 | 4.88 | 4.56 |
| | | C3, I3, I3L core speed grade | 9.8 | 9.0 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | 3 | C1, C2, C2L, I2, I2L core speed grade | 10.3125 | 10.3125 | 10.3125 | 10.3125 | 6.1 | 5.7 | 4.88 | 4.56 |
| | | I3YY core speed grade | 10.3125 | 10.3125 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | | C3, I3, I3L core speed grade | 8.5 | 8.5 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | | C4, I4 core speed grade | 8.5 | 8.2 | 7.04 | 6.56 | 4.4 | 4.1 | 3.52 | 3.28 |

Notes to Table 25:

- (1) The maximum data rate is in Gbps.
- (2) The Phase Compensation FIFO can be configured in FIFO mode or register mode. In the FIFO mode, the pointers are not fixed, and the latency can vary. In the register mode the pointers are fixed for low latency.
- (3) The maximum data rate is also constrained by the transceiver speed grade. Refer to Table 1 for the transceiver speed grade.

Table 26 shows the approximate maximum data rate using the 10G PCS.

Table 26. Stratix V 10G PCS Approximate Maximum Data Rate ⁽¹⁾

| Mode ⁽²⁾ | Transceiver Speed Grade | PMA Width | 64 | 40 | 40 | 40 | 32 | 32 |
|---------------------|-------------------------|---------------------------------------|--------------|-------|-------|------|----------|-------|
| | | PCS Width | 64 | 66/67 | 50 | 40 | 64/66/67 | 32 |
| FIFO or Register | 1 | C1, C2, C2L, I2, I2L core speed grade | 14.1 | 14.1 | 10.69 | 14.1 | 13.6 | 13.6 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.5 | 12.5 | 10.69 | 12.5 | 12.5 | 12.5 |
| | | C3, I3, I3L core speed grade | 12.5 | 12.5 | 10.69 | 12.5 | 10.88 | 10.88 |
| | 3 | C1, C2, C2L, I2, I2L core speed grade | 8.5 Gbps | | | | | |
| | | C3, I3, I3L core speed grade | | | | | | |
| | | C4, I4 core speed grade | | | | | | |
| | | I3YY core speed grade | 10.3125 Gbps | | | | | |

Notes to Table 26:

- (1) The maximum data rate is in Gbps.
- (2) The Phase Compensation FIFO can be configured in FIFO mode or register mode. In the FIFO mode, the pointers are not fixed, and the latency can vary. In the register mode the pointers are fixed for low latency.

Table 28. Transceiver Specifications for Stratix V GT Devices (Part 2 of 5) ⁽¹⁾

| Symbol/ Description | Conditions | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|---|---|--|---------------|--------|------------------------------|---------------|--------|----------|
| | | Min | Typ | Max | Min | Typ | Max | |
| Transmitter REFCLK Phase Noise (622 MHz) ⁽¹⁸⁾ | 100 Hz | — | — | -70 | — | — | -70 | dBc/Hz |
| | 1 kHz | — | — | -90 | — | — | -90 | |
| | 10 kHz | — | — | -100 | — | — | -100 | |
| | 100 kHz | — | — | -110 | — | — | -110 | |
| | ≥ 1 MHz | — | — | -120 | — | — | -120 | |
| Transmitter REFCLK Phase Jitter (100 MHz) ⁽¹⁵⁾ | 10 kHz to 1.5 MHz (PCIe) | — | — | 3 | — | — | 3 | ps (rms) |
| RREF ⁽¹⁷⁾ | — | — | 1800 ± 1% | — | — | 1800 ± 1% | — | Ω |
| Transceiver Clocks | | | | | | | | |
| fixedclk clock frequency | PCIe Receiver Detect | — | 100 or 125 | — | — | 100 or 125 | — | MHz |
| Reconfiguration clock (mgmt_clk_clk) frequency | — | 100 | — | 125 | 100 | — | 125 | MHz |
| Receiver | | | | | | | | |
| Supported I/O Standards | — | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS | | | | | | |
| Data rate (Standard PCS) ⁽²¹⁾ | GX channels | 600 | — | 8500 | 600 | — | 8500 | Mbps |
| Data rate (10G PCS) ⁽²¹⁾ | GX channels | 600 | — | 12,500 | 600 | — | 12,500 | Mbps |
| Data rate | GT channels | 19,600 | — | 28,050 | 19,600 | — | 25,780 | Mbps |
| Absolute V _{MAX} for a receiver pin ⁽³⁾ | GT channels | — | — | 1.2 | — | — | 1.2 | V |
| Absolute V _{MIN} for a receiver pin | GT channels | -0.4 | — | — | -0.4 | — | — | V |
| Maximum peak-to-peak differential input voltage V _{ID} (diff p-p) before device configuration ⁽²⁰⁾ | GT channels | — | — | 1.6 | — | — | 1.6 | V |
| | GX channels | ⁽⁸⁾ | | | | | | |
| Maximum peak-to-peak differential input voltage V _{ID} (diff p-p) after device configuration ⁽¹⁶⁾ , ⁽²⁰⁾ | GT channels V _{CCR_GTB} = 1.05 V (V _{ICM} = 0.65 V) | — | — | 2.2 | — | — | 2.2 | V |
| | GX channels | ⁽⁸⁾ | | | | | | |
| Minimum differential eye opening at receiver serial input pins ⁽⁴⁾ , ⁽²⁰⁾ | GT channels | 200 | — | — | 200 | — | — | mV |
| | GX channels | ⁽⁸⁾ | | | | | | |

Table 28. Transceiver Specifications for Stratix V GT Devices (Part 4 of 5) ⁽¹⁾

| Symbol/ Description | Conditions | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|--|--|------------------------------|-----|--------------------------------|------------------------------|-----|--------------------------------|------|
| | | Min | Typ | Max | Min | Typ | Max | |
| Data rate | GT channels | 19,600 | — | 28,050 | 19,600 | — | 25,780 | Mbps |
| Differential on-chip termination resistors | GT channels | — | 100 | — | — | 100 | — | Ω |
| | GX channels | (8) | | | | | | |
| V _{OCM} (AC coupled) | GT channels | — | 500 | — | — | 500 | — | mV |
| | GX channels | (8) | | | | | | |
| Rise/Fall time | GT channels | — | 15 | — | — | 15 | — | ps |
| | GX channels | (8) | | | | | | |
| Intra-differential pair skew | GX channels | (8) | | | | | | |
| Intra-transceiver block transmitter channel-to- channel skew | GX channels | (8) | | | | | | |
| Inter-transceiver block transmitter channel-to- channel skew | GX channels | (8) | | | | | | |
| CMU PLL | | | | | | | | |
| Supported Data Range | — | 600 | — | 12500 | 600 | — | 8500 | Mbps |
| t _{pll_powerdown} ⁽¹³⁾ | — | 1 | — | — | 1 | — | — | μs |
| t _{pll_lock} ⁽¹⁴⁾ | — | — | — | 10 | — | — | 10 | μs |
| ATX PLL | | | | | | | | |
| Supported Data Rate Range for GX Channels | VCO post- divider L=2 | 8000 | — | 12500 | 8000 | — | 8500 | Mbps |
| | L=4 | 4000 | — | 6600 | 4000 | — | 6600 | Mbps |
| | L=8 | 2000 | — | 3300 | 2000 | — | 3300 | Mbps |
| | L=8, Local/Central Clock Divider =2 | 1000 | — | 1762.5 | 1000 | — | 1762.5 | Mbps |
| Supported Data Rate Range for GT Channels | VCO post- divider L=2 | 9800 | — | 14025 | 9800 | — | 12890 | Mbps |
| t _{pll_powerdown} ⁽¹³⁾ | — | 1 | — | — | 1 | — | — | μs |
| t _{pll_lock} ⁽¹⁴⁾ | — | — | — | 10 | — | — | 10 | μs |
| fPLL | | | | | | | | |
| Supported Data Range | — | 600 | — | 3250/ 3.125 ⁽²³⁾ | 600 | — | 3250/ 3.125 ⁽²³⁾ | Mbps |
| t _{pll_powerdown} ⁽¹³⁾ | — | 1 | — | — | 1 | — | — | μs |

Figure 4 shows the differential transmitter output waveform.

Figure 4. Differential Transmitter/Receiver Output/Input Waveform

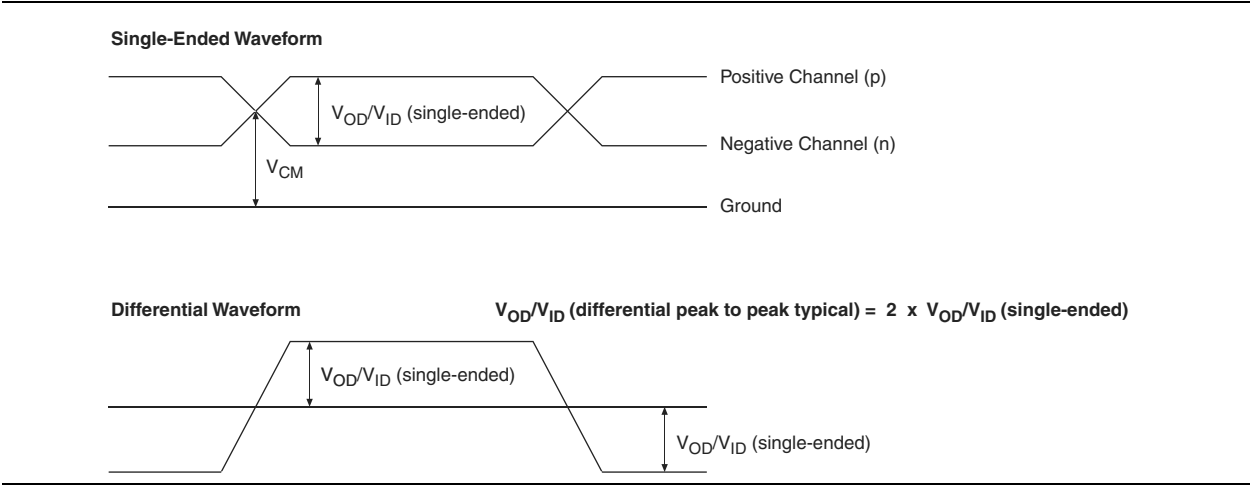


Figure 5 shows the Stratix V AC gain curves for GT channels.

Figure 5. AC Gain Curves for GT Channels

PLL Specifications

Table 31 lists the Stratix V PLL specifications when operating in both the commercial junction temperature range (0° to 85°C) and the industrial junction temperature range (–40° to 100°C).

Table 31. PLL Specifications for Stratix V Devices (Part 1 of 3)

| Symbol | Parameter | Min | Typ | Max | Unit |
|--------------------------|--|-----|-----|--------------------|------|
| f_{IN} | Input clock frequency (C1, C2, C2L, I2, and I2L speed grades) | 5 | — | 800 ⁽¹⁾ | MHz |
| | Input clock frequency (C3, I3, I3L, and I3YY speed grades) | 5 | — | 800 ⁽¹⁾ | MHz |
| | Input clock frequency (C4, I4 speed grades) | 5 | — | 650 ⁽¹⁾ | MHz |
| f_{INPFD} | Input frequency to the PFD | 5 | — | 325 | MHz |
| f_{FINPFD} | Fractional Input clock frequency to the PFD | 50 | — | 160 | MHz |
| f_{VCO} ⁽⁹⁾ | PLL VCO operating range (C1, C2, C2L, I2, I2L speed grades) | 600 | — | 1600 | MHz |
| | PLL VCO operating range (C3, I3, I3L, I3YY speed grades) | 600 | — | 1600 | MHz |
| | PLL VCO operating range (C4, I4 speed grades) | 600 | — | 1300 | MHz |
| $t_{EINDUTY}$ | Input clock or external feedback clock input duty cycle | 40 | — | 60 | % |
| f_{OUT} | Output frequency for an internal global or regional clock (C1, C2, C2L, I2, I2L speed grades) | — | — | 717 ⁽²⁾ | MHz |
| | Output frequency for an internal global or regional clock (C3, I3, I3L speed grades) | — | — | 650 ⁽²⁾ | MHz |
| | Output frequency for an internal global or regional clock (C4, I4 speed grades) | — | — | 580 ⁽²⁾ | MHz |
| f_{OUT_EXT} | Output frequency for an external clock output (C1, C2, C2L, I2, I2L speed grades) | — | — | 800 ⁽²⁾ | MHz |
| | Output frequency for an external clock output (C3, I3, I3L speed grades) | — | — | 667 ⁽²⁾ | MHz |
| | Output frequency for an external clock output (C4, I4 speed grades) | — | — | 553 ⁽²⁾ | MHz |
| $t_{OUTDUTY}$ | Duty cycle for a dedicated external clock output (when set to 50%) | 45 | 50 | 55 | % |
| t_{FCOMP} | External feedback clock compensation time | — | — | 10 | ns |
| $f_{DYCONFIGCLK}$ | Dynamic Configuration Clock used for <code>mgmt_clk</code> and <code>scanclk</code> | — | — | 100 | MHz |
| t_{LOCK} | Time required to lock from the end-of-device configuration or deassertion of <code>areset</code> | — | — | 1 | ms |
| t_{DLOCK} | Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays) | — | — | 1 | ms |
| f_{CLBW} | PLL closed-loop low bandwidth | — | 0.3 | — | MHz |
| | PLL closed-loop medium bandwidth | — | 1.5 | — | MHz |
| | PLL closed-loop high bandwidth ⁽⁷⁾ | — | 4 | — | MHz |
| t_{PLL_PSERR} | Accuracy of PLL phase shift | — | — | ±50 | ps |
| t_{ARESET} | Minimum pulse width on the <code>areset</code> signal | 10 | — | — | ns |

Table 36. High-Speed I/O Specifications for Stratix V Devices ^{(1), (2)} (Part 2 of 4)

| Symbol | Conditions | C1 | | | C2, C2L, I2, I2L | | | C3, I3, I3L, I3YY | | | C4,I4 | | | Unit |
|--|---|-----|-----|------|------------------|-----|------|-------------------|-----|------|-------|-----|------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Transmitter | | | | | | | | | | | | | | |
| True Differential I/O Standards - f _{HSDR} (data rate) | SERDES factor J = 3 to 10 ^{(9), (11), (12), (13), (14), (15), (16)} | (6) | — | 1600 | (6) | — | 1434 | (6) | — | 1250 | (6) | — | 1050 | Mbps |
| | SERDES factor J ≥ 4 LVDS TX with DPA ^{(12), (14), (15), (16)} | (6) | — | 1600 | (6) | — | 1600 | (6) | — | 1600 | (6) | — | 1250 | Mbps |
| | SERDES factor J = 2, uses DDR Registers | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | Mbps |
| | SERDES factor J = 1, uses SDR Register | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f _{HSDR} (data rate) ⁽¹⁰⁾ | SERDES factor J = 4 to 10 ⁽¹⁷⁾ | (6) | — | 1100 | (6) | — | 1100 | (6) | — | 840 | (6) | — | 840 | Mbps |
| t _{x Jitter} - True Differential I/O Standards | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | — | — | 160 | — | — | 160 | — | — | 160 | — | — | 160 | ps |
| | Total Jitter for Data Rate < 600 Mbps | — | — | 0.1 | — | — | 0.1 | — | — | 0.1 | — | — | 0.1 | UI |
| t _{x Jitter} - Emulated Differential I/O Standards with Three External Output Resistor Network | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | — | — | 300 | — | — | 300 | — | — | 300 | — | — | 325 | ps |
| | Total Jitter for Data Rate < 600 Mbps | — | — | 0.2 | — | — | 0.2 | — | — | 0.2 | — | — | 0.25 | UI |

Figure 7 shows the dynamic phase alignment (DPA) lock time specifications with the DPA PLL calibration option enabled.

Figure 7. DPA Lock Time Specification with DPA PLL Calibration Enabled

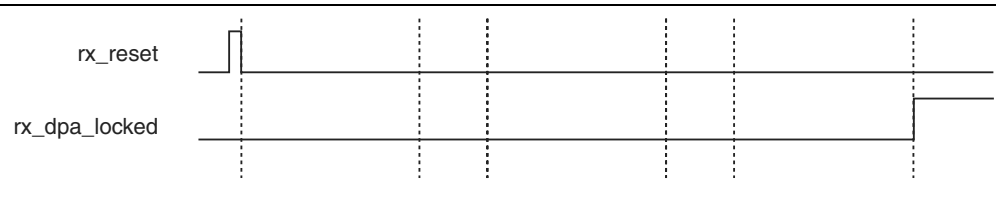


Table 37 lists the DPA lock time specifications for Stratix V devices.

Table 37. DPA Lock Time Specifications for Stratix V GX Devices Only ^{(1), (2), (3)}

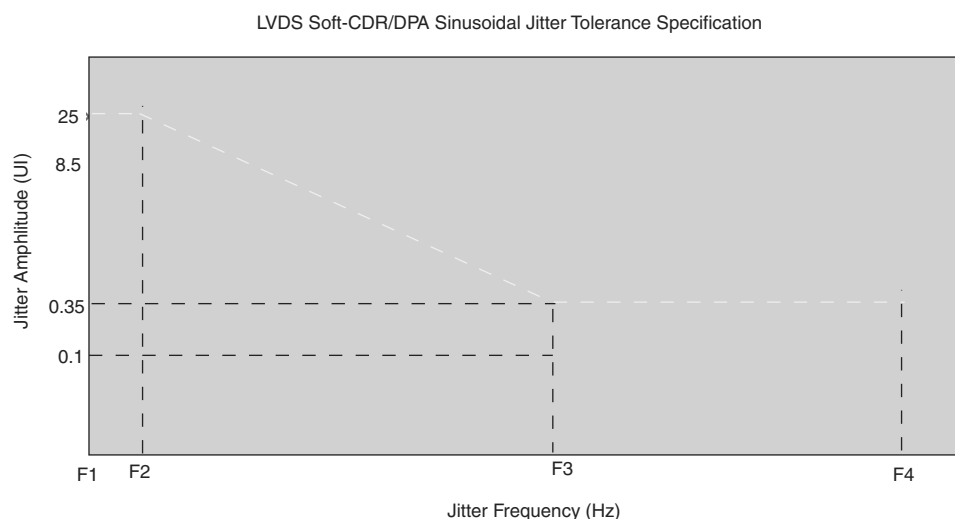
| Standard | Training Pattern | Number of Data Transitions in One Repetition of the Training Pattern | Number of Repetitions per 256 Data Transitions ⁽⁴⁾ | Maximum |
|--------------------|----------------------|--|---|----------------------|
| SPI-4 | 00000000001111111111 | 2 | 128 | 640 data transitions |
| Parallel Rapid I/O | 00001111 | 2 | 128 | 640 data transitions |
| | 10010000 | 4 | 64 | 640 data transitions |
| Miscellaneous | 10101010 | 8 | 32 | 640 data transitions |
| | 01010101 | 8 | 32 | 640 data transitions |

Notes to Table 37:

- (1) The DPA lock time is for one channel.
- (2) One data transition is defined as a 0-to-1 or 1-to-0 transition.
- (3) The DPA lock time stated in this table applies to both commercial and industrial grade.
- (4) This is the number of repetitions for the stated training pattern to achieve the 256 data transitions.

Figure 8 shows the LVDS soft-clock data recovery (CDR)/DPA sinusoidal jitter tolerance specification for a data rate ≥ 1.25 Gbps. Table 38 lists the LVDS soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate ≥ 1.25 Gbps.

Figure 8. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate ≥ 1.25 Gbps



Active Serial Configuration Timing

Table 52 lists the DCLK frequency specification in the AS configuration scheme.

Table 52. DCLK Frequency Specification in the AS Configuration Scheme ^{(1), (2)}

| Minimum | Typical | Maximum | Unit |
|---------|---------|---------|------|
| 5.3 | 7.9 | 12.5 | MHz |
| 10.6 | 15.7 | 25.0 | MHz |
| 21.3 | 31.4 | 50.0 | MHz |
| 42.6 | 62.9 | 100.0 | MHz |

Notes to Table 52:

- (1) This applies to the DCLK frequency specification when using the internal oscillator as the configuration clock source.
- (2) The AS multi-device configuration scheme does not support DCLK frequency of 100 MHz.

Figure 14 shows the single-device configuration setup for an AS ×1 mode.

Figure 14. AS Configuration Timing



Notes to Figure 14:

- (1) If you are using AS ×4 mode, this signal represents the AS_DATA [3 : 0] and EPCQ sends in 4-bits of data for each DCLK cycle.
- (2) The initialization clock can be from internal oscillator or CLKUSR pin.
- (3) After the option bit to enable the INIT_DONE pin is configured into the device, the INIT_DONE goes low.

Table 53 lists the timing parameters for AS ×1 and AS ×4 configurations in Stratix V devices.

Table 53. AS Timing Parameters for AS ×1 and AS ×4 Configurations in Stratix V Devices ^{(1), (2)} (Part 1 of 2)

| Symbol | Parameter | Minimum | Maximum | Units |
|----------|---|---------|---------|-------|
| t_{CO} | DCLK falling edge to AS_DATA0/ASDO output | — | 2 | ns |
| t_{SU} | Data setup time before falling edge on DCLK | 1.5 | — | ns |
| t_H | Data hold time after falling edge on DCLK | 0 | — | ns |

Table 53. AS Timing Parameters for AS ×1 and AS ×4 Configurations in Stratix V Devices ^{(1), (2)} (Part 2 of 2)

| Symbol | Parameter | Minimum | Maximum | Units |
|--------------|---|--|---------|-------|
| t_{CD2UM} | CONF_DONE high to user mode ⁽³⁾ | 175 | 437 | μs |
| t_{CD2CU} | CONF_DONE high to CLKUSR enabled | 4 × maximum DCLK period | — | — |
| t_{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | $t_{CD2CU} + (8576 \times \text{CLKUSR period})$ | — | — |

Notes to Table 53:

- (1) The minimum and maximum numbers apply only if you choose the internal oscillator as the clock source for initializing the device.
- (2) t_{CF2CD} , t_{CF2ST0} , t_{CFG} , t_{STATUS} , and t_{CF2ST1} timing parameters are identical to the timing parameters for PS mode listed in Table 54 on page 63.
- (3) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on this pin, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.

Passive Serial Configuration Timing

Figure 15 shows the timing waveform for a passive serial (PS) configuration when using a MAX II device, MAX V device, or microprocessor as an external host.

Figure 15. PS Configuration Timing Waveform ⁽¹⁾**Notes to Figure 15:**

- (1) The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF_DONE are at logic high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- (2) After power-up, the Stratix V device holds nSTATUS low for the time of the POR delay.
- (3) After power-up, before and during configuration, CONF_DONE is low.
- (4) Do not leave DCLK floating after configuration. You can drive it high or low, whichever is more convenient.
- (5) DATA0 is available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings in the **Device and Pins Option**.
- (6) To ensure a successful configuration, send the entire configuration data to the Stratix V device. CONF_DONE is released high after the Stratix V device receives all the configuration data successfully. After CONF_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- (7) After the option bit to enable the INIT_DONE pin is configured into the device, the INIT_DONE goes low.

Remote System Upgrades

Table 56 lists the timing parameter specifications for the remote system upgrade circuitry.

Table 56. Remote System Upgrade Circuitry Timing Specifications

| Parameter | Minimum | Maximum | Unit |
|--------------------------|---------|---------|------|
| $t_{RU_nCONFIG}^{(1)}$ | 250 | — | ns |
| $t_{RU_nRSTIMER}^{(2)}$ | 250 | — | ns |

Notes to Table 56:

- (1) This is equivalent to strobing the reconfiguration input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the Remote System Upgrade State Machine section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (2) This is equivalent to strobing the reset_timer input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the User Watchdog Timer section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.

User Watchdog Internal Circuitry Timing Specification

Table 57 lists the operating range of the 12.5-MHz internal oscillator.

Table 57. 12.5-MHz Internal Oscillator Specifications

| Minimum | Typical | Maximum | Units |
|---------|---------|---------|-------|
| 5.3 | 7.9 | 12.5 | MHz |

I/O Timing

Altera offers two ways to determine I/O timing—the Excel-based I/O Timing and the Quartus II Timing Analyzer.

Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II Timing Analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after you complete place-and-route.



You can download the Excel-based I/O Timing spreadsheet from the Stratix V Devices Documentation web page.

Programmable IOE Delay

Table 58 lists the Stratix V IOE programmable delay settings.

Table 58. IOE Programmable Delay for Stratix V Devices (Part 1 of 2)

| Parameter (1) | Available Settings | Min Offset (2) | Fast Model | | Slow Model | | | | | | | |
|------------------|-----------------------|----------------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|------|
| | | | Industrial | Commercial | C1 | C2 | C3 | C4 | I2 | I3, I3YY | I4 | Unit |
| D1 | 64 | 0 | 0.464 | 0.493 | 0.838 | 0.838 | 0.924 | 1.011 | 0.844 | 0.921 | 1.006 | ns |
| D2 | 32 | 0 | 0.230 | 0.244 | 0.415 | 0.415 | 0.459 | 0.503 | 0.417 | 0.456 | 0.500 | ns |

Table 61. Document Revision History (Part 2 of 3)

| Date | Version | Changes |
|---------------|---------|--|
| November 2014 | 3.3 | <ul style="list-style-type: none"> ■ Added the I3YY speed grade and changed the data rates for the GX channel in Table 1. ■ Added the I3YY speed grade to the V_{CC} description in Table 6. ■ Added the I3YY speed grade to V_{CCHIP_L}, V_{CCHIP_R}, V_{CCHSSI_L}, and V_{CCHSSI_R} descriptions in Table 7. ■ Added 240-Ω to Table 11. ■ Changed CDR PPM tolerance in Table 23. ■ Added additional max data rate for fPLL in Table 23. ■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 25. ■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 26. ■ Changed CDR PPM tolerance in Table 28. ■ Added additional max data rate for fPLL in Table 28. ■ Changed the mode descriptions for MLAB and M20K in Table 33. ■ Changed the Max value of f_{HCLK_OUT} for the C2, C2L, I2, I2L speed grades in Table 36. ■ Changed the frequency ranges for C1 and C2 in Table 39. ■ Changed the .rbf file sizes for 5SGSD6 and 5SGSD8 in Table 47. ■ Added note about nSTATUS to Table 50, Table 51, Table 54. ■ Changed the available settings in Table 58. ■ Changed the note in “Periphery Performance”. ■ Updated the “I/O Standard Specifications” section. ■ Updated the “Raw Binary File Size” section. ■ Updated the receiver voltage input range in Table 22. ■ Updated the max frequency for the LVDS clock network in Table 36. ■ Updated the DCLK note to Figure 11. ■ Updated Table 23 VO_{CM} (DC Coupled) condition. ■ Updated Table 6 and Table 7. ■ Added the DCLK specification to Table 55. ■ Updated the notes for Table 47. ■ Updated the list of parameters for Table 56. |
| November 2013 | 3.2 | ■ Updated Table 28 |
| November 2013 | 3.1 | ■ Updated Table 33 |
| November 2013 | 3.0 | ■ Updated Table 23 and Table 28 |
| October 2013 | 2.9 | ■ Updated the “Transceiver Characterization” section |
| October 2013 | 2.8 | <ul style="list-style-type: none"> ■ Updated Table 3, Table 12, Table 14, Table 19, Table 20, Table 23, Table 24, Table 28, Table 30, Table 31, Table 32, Table 33, Table 36, Table 39, Table 40, Table 41, Table 42, Table 47, Table 53, Table 58, and Table 59 ■ Added Figure 1 and Figure 3 ■ Added the “Transceiver Characterization” section ■ Removed all “Preliminary” designations. |